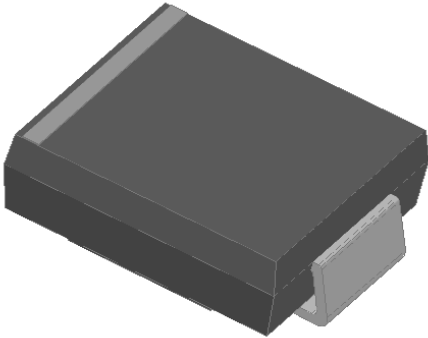


Surface Mount General Purpose Rectifier

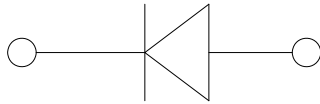


Features

- High efficiency
- High current capability
- High reliability
- High surge current capability
- Low power loss
- Solder dip 260 °C max. 10 s, per JESD 22-B106
- Part no. with suffix "Q" means AEC-Q101 qualified

Typical Applications

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive and telecommunication.



Mechanical Data

- **Package:** DO-214AB (SMC)
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solder able per J-STD-002 and JESD22-B102
- **Polarity:** Color band denotes cathode end

■Maximum Ratings (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GS8AQ	GS8BQ	GS8DQ	GS8GQ	GS8JQ	GS8KQ	GS8MQ
Device marking code			GS8A	GS8B	GS8D	GS8G	GS8J	GS8K	GS8M
Repetitive Peak Reverse Voltage	V _{RRM}	V	50	100	200	400	600	800	1000
Maximum RMS voltage	V _{RMS}	V	35	70	140	280	420	560	700
Average Rectified Output Current @60Hz sine wave, Resistance load, T _L (FIG.1)	I _O	A	8.0						
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, T _a =25°C	I _{FSM}	A	200						
Storage Temperature	T _{STG}	°C	-55 ~+150						
Junction Temperature	T _J	°C	-55 ~+150						

■Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GS8AQ	GS8BQ	GS8DQ	GS8GQ	GS8JQ	GS8KQ	GS8MQ
Maximum instantaneous forward voltage drop per diode	V _F	V	I _{FM} =8.0A	1.1						
Maximum DC reverse current at rated DC blocking voltage per diode	I _R	μA	T _a =25°C	10						
			T _a =125°C	250						
Typical junction capacitance	C _J	pF	1MHz, V _R =4V.	70					60	



GS8AQ THRU GS8MQ

■ Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	GS8AQ	GS8BQ	GS8DQ	GS8GQ	GS8JQ	GS8KQ	GS8MQ
Thermal Resistance	Junction to ambient	R _{θJ-A}	°C/W	75 ^①						
	Junction to lead	R _{θJ-L}		12 ^①						

Note(1)

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16 mm) copper pad areas

■ Characteristics(Typical)

Fig.1: I_O-T_L Curve

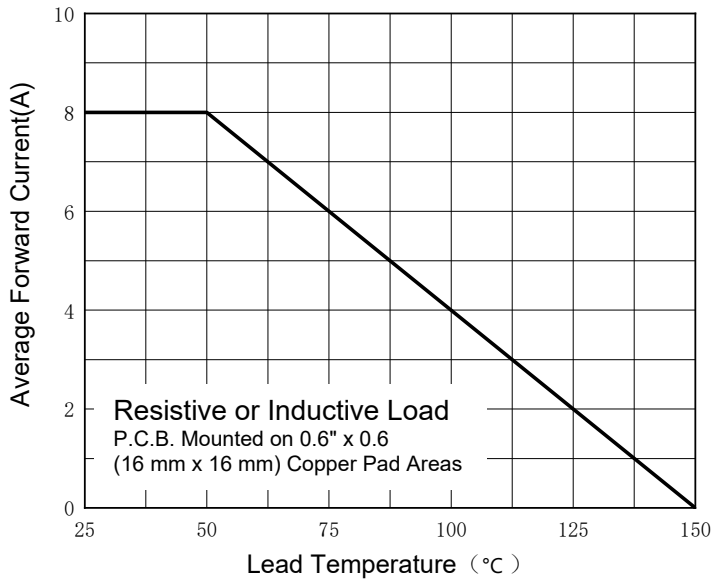


Fig.2: Surge Forward Current Capability

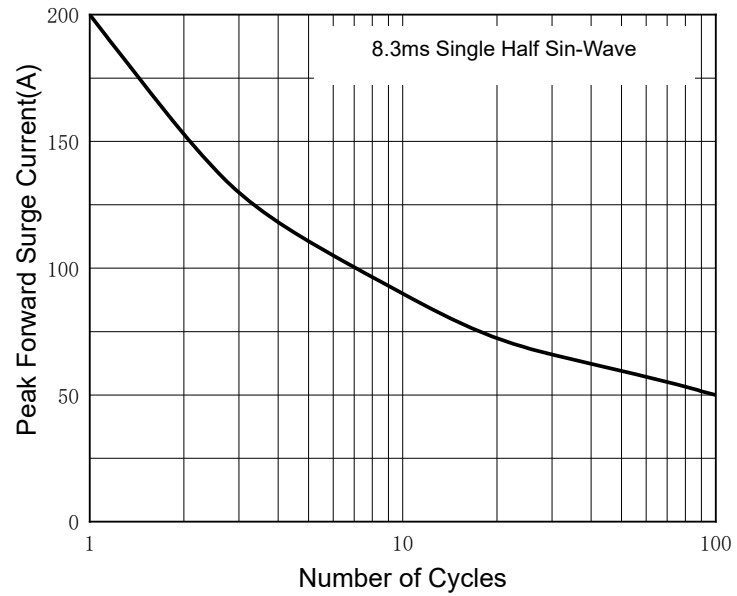


Fig.3: Typical Forward Characteristics

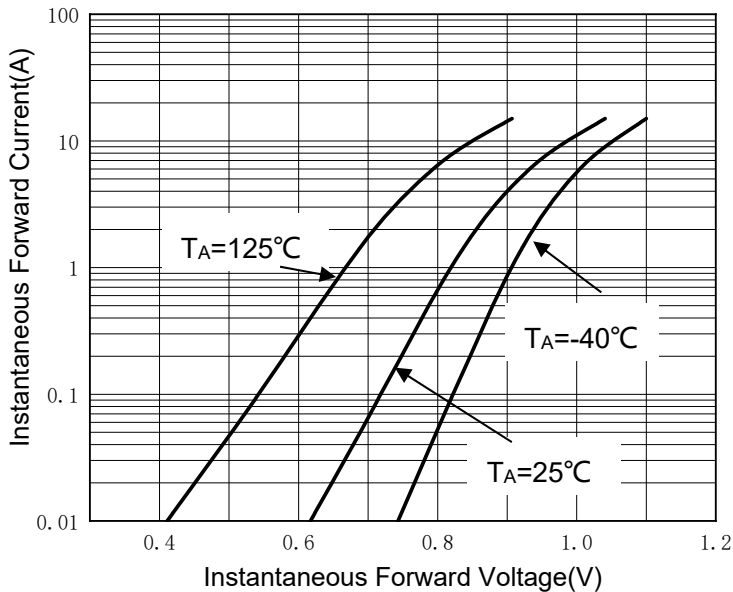
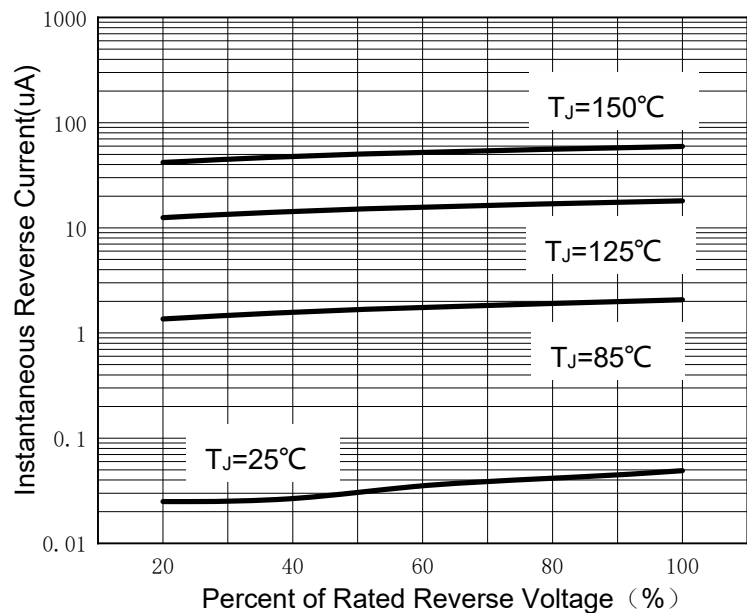


Fig.4: Typical Reverse Characteristics



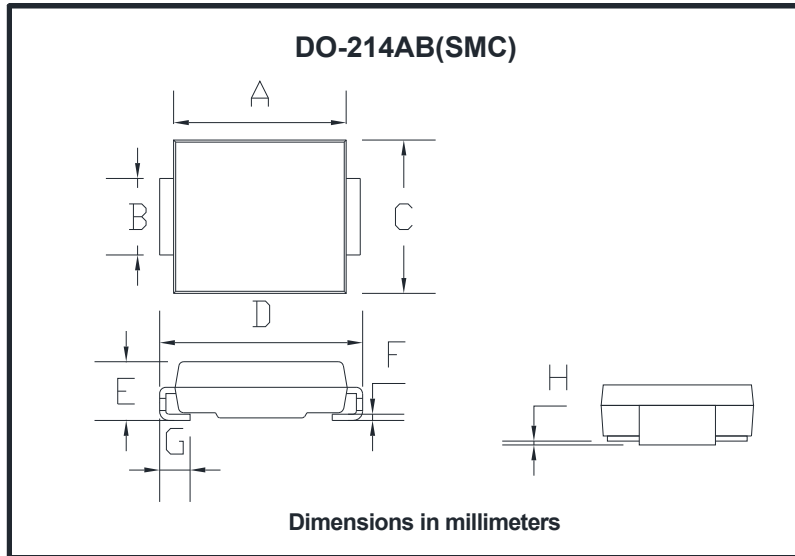


GS8AQ THRU GS8MQ

■ Ordering Information (Example)

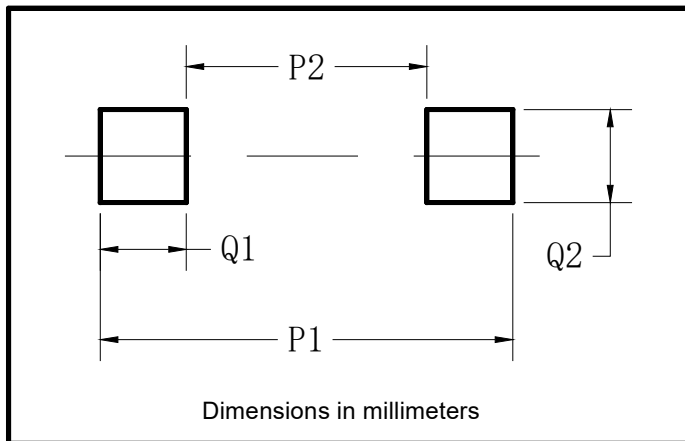
PREFERRED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GS8AQ~GS8MQ	F1	Approximate 0.253	3000	/	42000	13" reel

■ Outline Dimensions



DO-214AB (SMC)		
Dim	Min	Max
A	6.60	7.11
B	2.85	3.27
C	5.59	6.22
D	7.75	8.13
E	1.99	2.61
F	0.15	0.31
G	0.76	1.52
H	0.05	0.20

■ Suggested pad layout



Dim	Typ
P1	9.9
P2	3.84
Q1	3.03
Q2	3.82



GS8AQ THRU GS8MQ

Disclaimer

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